



Certificate of Registration

QUALITY MANAGEMENT SYSTEM - ISO 9001:2008

This is to certify that:

**Cookson Electronics
Assembly Materials Group
Corporate Boulevard
South Plainfield
New Jersey
07080
USA**

Holds Certificate No: **FM 81410**

and operates a Quality Management System which complies with the requirements of ISO 9001:2008 for the following scope:

The design, manufacture, storage, distribution, sale and service of product lines used in printed circuit board fabrication, electronics assembly, semi-conductor packaging and industrial applications. Product range includes solder products (e.g. bars and wires), solder paste, lead free alloys, soldering fluxes and related chemical products, laser cut stencils and chemically etched stencils, including the recycling of solder materials.

For and on behalf of BSI:

President, BSI America, Inc.

Originally Registered: **11/23/2003**

Latest Issue: **10/21/2009**

Expiry Date: **11/15/2012**



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Certificate No: **FM 81410**

Location

Registered Activities

Cookson Electronics
Assembly Materials Group
Corporate Boulevard
South Plainfield
New Jersey
07080
USA

Corporate Management New Product Development (including Sales and Marketing) and Technology Transfer Support for the design, manufacture and service of product lines used in printed wire boards (PWB) fabrication and electronics assembly. Product range includes solder powders, paste fluxes, and solder paste. Products are produced to ASTM, J-standards, company standards, or customer designed specification.

Cookson Electronics
Assembly Materials Group
4100 Sixth Avenue
Altoona
Pennsylvania
16602
USA

The manufacture of solder alloy products for the electronics industry and industrial applications. Recycling of solder materials.

Cookson Electronics
Assembly Materials Group
778 Main Street
Johnson City
New York
13790
USA

The manufacture of laser and chemically etched metal mask stencils and pre-sensitized/imaged screens.

Cookson Electronics Mexico S.A. de C.V.
Av. Nafta No. 800
Parque Ind. STIVA Aeropuerto
Apodaca
Nuevo León
66600
Mexico

The manufacture of paste flux, solder paste, core and solid wire, consumer solder wire, stencils and distribution of assembly chemicals.

Cookson Electronics Brasil Ltda.
Av. José Odorizzi, 650
São Bernardo do Campo
São Paulo
09810-000
Brasil

The manufacture and sale of tin alloy solders, solders, stencils for surface mount technology (SMT), and auxiliary products for soldering (fluxes, solvents, cleaners) and chemical products for surface finishing treatment and printed circuit board manufacturing.

Fabricação e comercialização de soldas com ligas a base de estanho, stencils para tecnologia de montagem de superfície (SMT), produtos auxiliares para soldagem (fluxos, diluentes, removedores e cleaners) e produtos Químicos para tratamento de superfície e fabricação de circuito impresso.

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Location

Cookson Electronics Brasil Ltda
Rua Tucunaré, 40
Distrito Industrial
Manaus
Amazonas
69075 231
Brasil

Registered Activities

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